



## **ASE SPONSORS 2005 FSA SUPPLIERS EXPO AND CONFERENCE**

Santa Clara, California, September 27, 2005 – Advanced Semiconductor Engineering Incorporated (ASE, TAIEX: 2311, NYSE: ASX), the world's largest semiconductor packaging and test company, announced today it will be a platinum sponsor for the 2005 FSA Suppliers Expo and Conference. The event will be held from October 5-6 at the San Jose McEnergy Convention Center in San Jose.

The event brings together semiconductor industry professionals from around the globe to cultivate and further business partnerships. It features a forum for over 100 exhibitors to showcase their products and services and provides two days of business education focusing on key topics in the semiconductor sector.

"ASE recognizes that the FSA continues to play a significant part in fostering growth in the relationship between the fabless and foundry communities," commented Dr. Tien Wu, President, Americas/Europe and Worldwide Marketing & Sales, ASE Group. "By bringing industry players together, everyone benefits by better understanding the future direction of the fabless model. ASE is proud to sponsor the FSA Suppliers Expo."

"We thank ASE Group for its global support, sponsoring not only FSA's Suppliers Expo, but also FSA's Expo TAIWAN, for the second year in a row," said Jodi Shelton, co-founder and executive director of FSA. "ASE Group has been an FSA member for five years. We appreciate the company's involvement in the association including its leadership role on our Board of Directors."

For additional information about the event or to register, visit [www.fsa.org/suppliers\\_expo/usa](http://www.fsa.org/suppliers_expo/usa). To schedule a meeting with ASE, contact Jennifer Yuen at [jennifer.yuen@aseus.com](mailto:jennifer.yuen@aseus.com) or 408.986.6519.

### **About ASE Group**

The ASE Group is the world's largest provider of independent semiconductor manufacturing services in assembly and test. As a global leader geared towards meeting the industry's ever growing needs for faster, smaller and higher performance chips, the Group develops and offers a wide portfolio of technology and solutions including IC test program design, front-end engineering test, wafer probe, wafer bump, substrate design and supply,

wafer level package, flip chip, system-in-package, final test and electronic manufacturing services through Universal Scientific Industrial Co Ltd, a member of the ASE Group. The Group generated sales revenues of \$2.45 billion in 2004 and employs over 32,000 people worldwide. For more information about the ASE Group, visit [www.aseglobal.com](http://www.aseglobal.com).

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